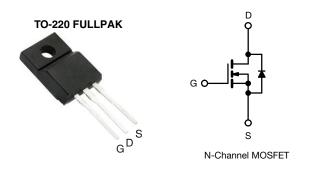
IRLI520G

Vishay Siliconix



Power MOSFET



| PRODUCT SUMMA | RY | |
|----------------------------|----------------|------|
| V _{DS} (V) | 100 |) |
| R _{DS(on)} (Ω) | $V_{GS} = 5 V$ | 0.27 |
| Q _g (Max.) (nC) | 12 | |
| Q _{gs} (nC) | 3.0 | |
| Q _{gd} (nC) | 7.1 | |
| Configuration | Sing | le |

FEATURES

- Isolated package
- High voltage isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to lead creepage distance = 4.8 mm
- Logic-level gate drive
- $R_{DS (on)}$ specified at $V_{GS} = 4$ V and 5 V
- Fast switching
- · Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

| ORDERING INFORMATION | |
|----------------------|----------------|
| Package | TO-220 FULLPAK |
| Lead (Pb)-free | IRLI520GPbF |

| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
|---|----------------------------------|-----------------------------------|-----------------|------------------|------|--|
| Drain-source voltage | | | V _{DS} | 100 | v | |
| Gate-source voltage | | V _{GS} | ± 10 | | | |
| Continuous drain current | $T_{\rm C} = 25 ^{\circ}{\rm C}$ | | | 7.2 | | |
| | | T _C = 100 °C | I _D | 5.1 | Α | |
| Pulsed drain current ^a | | | I _{DM} | 29 | | |
| Linear derating factor | | | | 0.24 | W/°C | |
| Single pulse avalanche energy b | | | E _{AS} | 170 | mJ | |
| Repetitive avalanche current ^a | | | I _{AR} | 7.2 | Α | |
| Repetitive avalanche energy ^a | | | E _{AR} | 3.7 | mJ | |
| Maximum power dissipation $T_{C} = 25 \text{ °C}$ | | 25 °C | PD | 37 | W | |
| Peak diode recovery dV/dt ^c | | dV/dt | 5.5 | V/ns | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +175 | °C | | |
| Soldering recommendations (peak temperature) ^d | For | 10 s | | 300 ^d | | |
| Mounting torque | M3 s | screw | | 0.6 | Nm | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 4.9 mH, R_G = 25 Ω , I_{AS} = 7.2 A (see fig. 12)

c. $I_{SD} \leq 9.2$ A, dI/dt ≤ 110 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^\circ C$

d. 1.6 mm from case

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| PARAMETER | SYMBOL | TYP | | MAX. | | | UNIT | | |
|---|-----------------------|--|---|--|------|----------|-------|------|--|
| Maximum junction-to-ambient | R _{thJA} | - | - | 65 | | | | | |
| Maximum junction-to-case (drain) | R _{thJC} | - | | 4.1 | | - | °C/W | | |
| | | | | | | | | | |
| SPECIFICATIONS T _J = 25 °C, u | nless otherwi | se noted | | | | | | | |
| PARAMETER | SYMBOL | TES | T CONDITI | ONS | MIN. | TYP. | MAX. | UNIT | |
| Static | | • | | | • | • | • | | |
| Drain-ssource breakdown voltage | V _{DS} | V _{GS} = | = 0 V, I _D = 2 | 50 µA | 100 | - | - | V | |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, | I _D = 1 mA | - | 0.12 | - | V/°C | |
| Gate-source threshold voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 2 | 50 µA | 1.0 | - | 2.0 | V | |
| Gate-source leakage | I _{GSS} | , | $V_{GS} = \pm 10^{\circ}$ | V | - | - | ± 100 | nA | |
| | | V _{DS} = | = 100 V, V _{GS} | = 0 V | - | - | 25 | 1 | |
| Zero gate voltage drain current | IDSS | V _{DS} = 80 V | V _{GS} = 0 V, | T _J = 150 °C | - | - | 250 | μA | |
| | 6 | $V_{GS} = 5 V$ | I _D | = 4.3 A ^b | - | - | 0.27 | | |
| Drain-source on-state resistance | R _{DS (on)} | $V_{GS} = 4 V$ | I _D | = 3.6 A ^b | - | - | 0.38 | Ω | |
| Forward transconductance | 9 _{fs} | V _{DS} = | = 50 V, I _D = - | 4.3 A ^b | 3.3 | - | - | S | |
| Dynamic | | • | | | | | | | |
| Input capacitance | C _{iss} | N 0.1 | | - | 490 | - | | | |
| Output capacitance | C _{oss} | | V _{GS} = 0 V, V _{DS} = 25 V, | | - | 150 | - | 1_ | |
| Reverse transfer capacitance | C _{rss} | f = 1.0 MHz, see fig. 5 | | - | 30 | - | pF | | |
| Drain to sink capacitance | С | | f = 1.0 MHz | 2 | - | 12 | - | | |
| Total gate charge | Qg | | | | - | - | 12 | | |
| Gate-source charge | Q _{gs} | V _{GS} = 5 V | | A, V _{DS} = 80 V, J. 6 and 13 ^b | - | - | 3.0 | nC | |
| Gate-drain charge | Q _{gd} | | 566 H | J. O and 15 | - | - | 7.1 | | |
| Turn-on delay time | t _{d(on)} | | 1 | | - | 9.8 | - | | |
| Rise time | t _r | | = 50 V, I _D = | | - | 64 | - | | |
| Turn-off delay time | t _{d(off)} | - R _G = | = 9 Ω _, R _D = 5 see fig. 10 ^t | | - | 21 | - | ns | |
| Fall time | t _f | | | - | 27 | - | 1 | | |
| Internal drain inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | | | |
| Internal source inductance | Ls | | | - | 7.5 | - | - nH | | |
| Drain-Source Body Diode Characteristic | cs | | | | 1 | <u> </u> | I | | |
| Continuous source-drain diode current | I _S | MOSFET sym showing the | | | - | - | 7.2 | А | |
| Pulsed diode forward current ^a | I _{SM} | integral revers p - n junction | | | - | - | 29 | ~ | |
| Body diode voltage | V_{SD} | T _J = 25 °C | , I _S = 7.2 A, | $V_{GS} = 0 V^{b}$ | - | - | 2.5 | V | |
| Body diode reverse recovery time | t _{rr} | T 25 °C I | سه ۵۵۸ – | dt - 100 A (uch | - | 130 | 190 | ns | |
| Body diode reverse recovery charge | Q _{rr} | $I_{\rm J} = 25^{-1} \rm C, I_{\rm F}$ | = 9.2 A, dl/ | dt = 100 A/µs ^b | - | 0.83 | 1.0 | μC | |
| Franciscul Association (Sec.) | + | linduite of a l | | a nagligituta (t | | | | | |

Forward turn-on time ton Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 $\,\%$

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

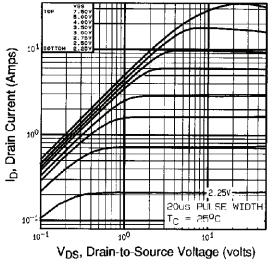


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

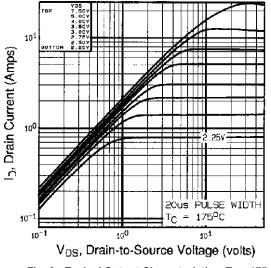
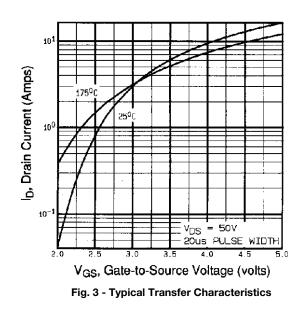


Fig. 2 - Typical Output Characteristics, T_C = 175 °C



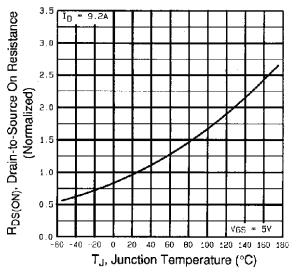


Fig. 4 - Normalized On-Resistance vs. Temperature



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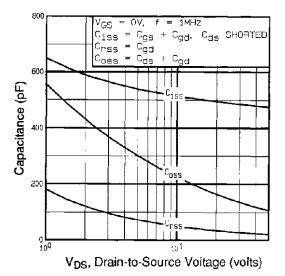


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

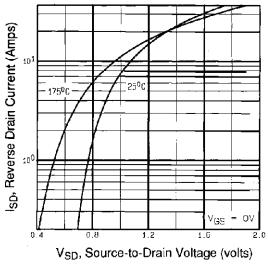


Fig. 7 - Typical Source-Drain Diode Forward Voltage

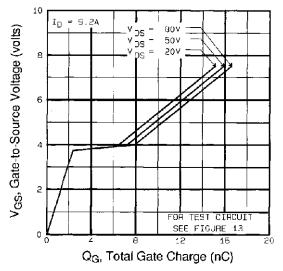
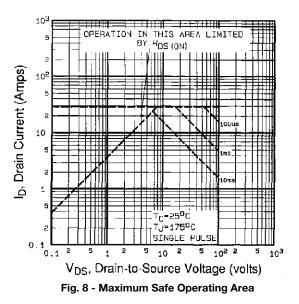


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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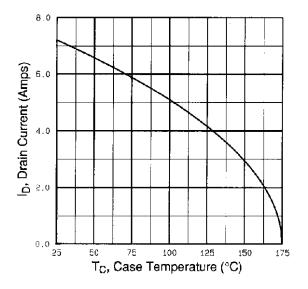


Fig. 9 - Maximum Drain Current vs. Case Temperature

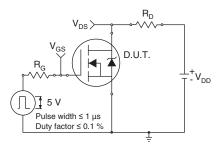


Fig. 10a - Switching Time Test Circuit

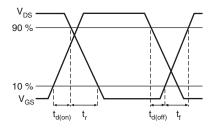
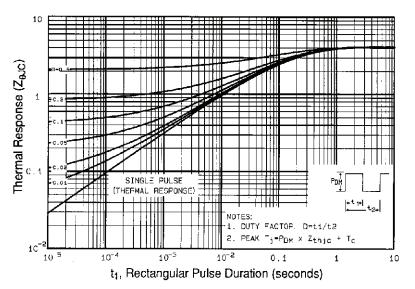


Fig. 10b - Switching Time Waveforms





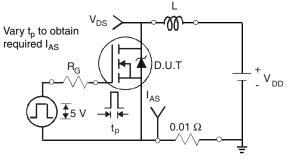
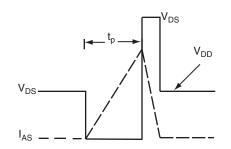
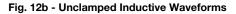


Fig. 12a - Unclamped Inductive Test Circuit





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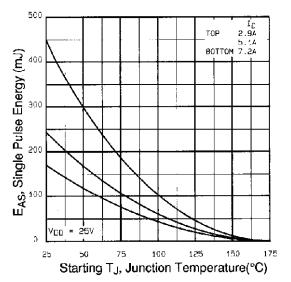


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

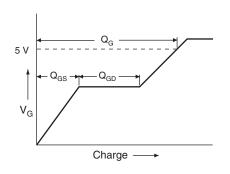


Fig. 13a - Basic Gate Charge Waveform

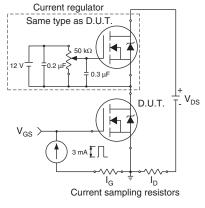
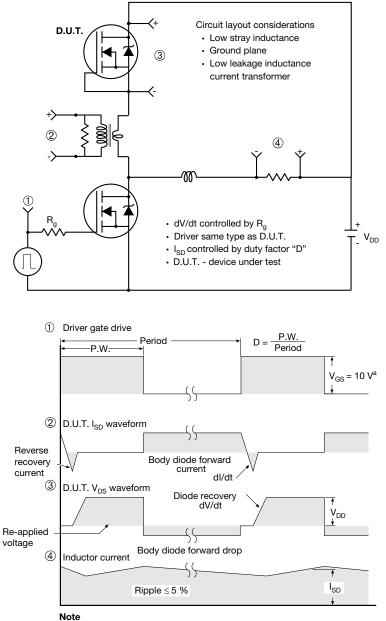


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig.14 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



| | | MILLIMETERS | | | | |
|------|----------|-------------|-------|--|--|--|
| DIM. | MIN. | NOM. | MAX. | | | |
| A | 4.60 | 4.70 | 4.80 | | | |
| b | 0.70 | 0.80 | 0.91 | | | |
| b1 | 1.20 | 1.30 | 1.47 | | | |
| b2 | 1.10 | 1.20 | 1.30 | | | |
| С | 0.45 | 0.50 | 0.63 | | | |
| D | 15.80 | 15.87 | 15.97 | | | |
| е | 2.54 BSC | | | | | |
| E | 10.00 | 10.10 | 10.30 | | | |
| F | 2.44 | 2.54 | 2.64 | | | |
| G | 6.50 | 6.70 | 6.90 | | | |
| L | 12.90 | 13.10 | 13.30 | | | |
| L1 | 3.13 | 3.23 | 3.33 | | | |
| Q | 2.65 | 2.75 | 2.85 | | | |
| Q1 | 3.20 | 3.30 | 3.40 | | | |
| ØR | 3.08 | 3.18 | 3.28 | | | |

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



| | MILLIMETERS | | INCHES | |
|------|-------------|--------|--------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| А | 4.570 | 4.830 | 0.180 | 0.190 |
| A1 | 2.570 | 2.830 | 0.101 | 0.111 |
| A2 | 2.510 | 2.850 | 0.099 | 0.112 |
| b | 0.622 | 0.890 | 0.024 | 0.035 |
| b2 | 1.229 | 1.400 | 0.048 | 0.055 |
| b3 | 1.229 | 1.400 | 0.048 | 0.055 |
| С | 0.440 | 0.629 | 0.017 | 0.025 |
| D | 8.650 | 9.800 | 0.341 | 0.386 |
| d1 | 15.88 | 16.120 | 0.622 | 0.635 |
| d3 | 12.300 | 12.920 | 0.484 | 0.509 |
| E | 10.360 | 10.630 | 0.408 | 0.419 |
| е | 2.54 | BSC | 0.100 |) BSC |
| L | 13.200 | 13.730 | 0.520 | 0.541 |
| L1 | 3.100 | 3.500 | 0.122 | 0.138 |
| n | 6.050 | 6.150 | 0.238 | 0.242 |
| ØP | 3.050 | 3.450 | 0.120 | 0.136 |
| u | 2.400 | 2.500 | 0.094 | 0.098 |
| V | 0.400 | 0.500 | 0.016 | 0.020 |

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
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